EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	27	dechuck$4 with ground$3	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/07 09:07
S4	23	clamp$3 with carrier with frame with chuck	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 07:58
S5	117	clamp$3 same frame same chuck same (substrate or wafer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/03 09:00
S20	99	clamp$3 with (substrate or wafer) same (frame or mask) same (carrier or plate with polyimide)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/03 09:07
S21	3304	(substrate or wafer) adj clamp$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/03 10:13
S23	5317	(118/728,729,500,503 or 156/345. 51).ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 10:22
S24	205	S21 and S23	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 09:10
S25	1	("5997651").PN. OR ("6267821"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 09:16

S26	34	("4086870" | "4189230" | "4282924" | "4473455" | "4592308" | "4671204" | "4975621" | "5094885" | "5183402" | "5228501" | "5238499" | "5262029" | "5304248" | "5316278" | "5326725" | "5391275" | "5405491" | "5421401" | "5437757" | "5460703" | "5476548" | "5484011" | "5534072" | "5534110" | "5578164" | "5632873" | "5695567" | "5711815" | "5762714" | "5810931" | "5851299" | "5972114").PN. OR ("6176931").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 09:18
S27	14	("4932358" | "4978412" | "5304248" | "5632873" | "5711815" | "5740009" | "5766363" | "5851299" | "5925226" | "5925227" | "5997651" | "6176931" | "6440219").PN. OR ("6641672"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 09:19
S28	3180	clamp$3 with (carrier or plate) with (substrate or wafer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/03 09:38
S29	101	S23 and S28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/03 09:32
S30	555	clamp$3 with (substrate or wafer) same (carrier or plate) same electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/03 09:43
S32	30	S23 and S30	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/03 09:39

S33	14	("4457359" | "4508161" | "4512391" | "4542298" | "4680061" | "4743570" | "4903754" | "4909314" | "4949783" | "5513594" | "5534110" | "6039854" | "6440219").PN. OR ("6547559"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 09:42
S34	137	clamp$3 with (substrate or wafer) same (carrier or plate) same electrode	EPO; JPO; DERWENT	OR	ON	2007/05/03 09:49
S40	117	(substrate or wafer) with (plate or carrier) with clamp$3 and polyimide and dielectric	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 09:58
S41	43	(substrate or wafer) with (plate or carrier) with clamp$3 and polyimide and dielectric and chuck	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 10:02
S42	3	(jurgen with weichart).in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/03 09:59
S43	3180	(substrate or wafer) with clamp$3 with (plate or carrier)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/03 10:14
S44	712	(substrate or wafer) with clamp$3 with (plate or carrier) same (lower$4 or transport$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/03 10:15
S45	25	(substrate or wafer) with clamp$3 with (plate or carrier) same polyimide	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/03 10:17
S46	75	(substrate or wafer) same clamp$3 same (plate or carrier) same polyimide	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/03 10:18

EAST Search History

S47	2391	(118/728,729).ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 10:22
S48	409	(118/728,729).ccls. and (substrate or wafer) with clamp$3	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 10:31
S49	0	(118/728,729).ccls. and polyimide with (plate or carrier) with (frame or mask) with (substrate or wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 10:35
S50	64	(118/728,729).ccls. and (plate or carrier) with (frame or mask) with (substrate or wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 10:39
S51	157	polyimide same (plate or carrier) with (frame or mask) with (substrate or wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 10:43
S52	1787	(frame or mask) with (substrate or wafer) with (lower$4 or transport$4) with electrode	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 10:45
S53	2	S47 and S52	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 10:44
S54	4771	(substrate or wafer) same (carrier or plate) same (clamp$4 or hold$4 or transport$4) same (frame or mask)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 10:46
S55	73	S47 and S54	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 11:03
S56	3546	(substrate or wafer) with carrier with adhesive	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 11:06
S57	1	S47 and S56	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 11:04
S58	69102	(substrate or wafer) with carrier	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 11:06
S59	410	S47 and S58	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 11:22
S60	2	polyimide with film with frame with (substrate or wafer) with clamp$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 11:23
S61	66	film with frame with (substrate or wafer) with clamp$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 11:32

EAST Search History

S62	8	("20020177875" | "20040111875" | "3973682" | "4829665" | "4850780" | "5203143" | "5894657" | "6706130").PN. OR ("7069647").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 11:25
S63	5	polyimide with film with (substrate or wafer) with clamp$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 11:34
S64	11147	film with clamp$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 11:34
S65	43	S47 and S64	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 13:29
S66	301	S47 and (substrate or wafer) with clamp	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 13:31
S67	22	S47 and (substrate or wafer) with clamp with film	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 13:34
S68	65	S47 and (substrate or wafer) same clamp same film	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 13:34
S69	92	S47 and (substrate or wafer) same clamp$3 same film	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 13:38
S70	6	S24 and (substrate or wafer) same clamp$3 same polyimide	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 13:39
S71	26	S24 and (substrate or wafer) with clamp$3 with film	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 13:44
S72	847	118/729.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 14:21
S73	442	414/941.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 14:43
S74	53	S73 and electrode	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 14:21
S75	119	S73 and chuck	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 16:17
S76	2309	414/935-941.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 14:43

EAST Search History

S77	60	S76 and chuck near (electrode or electrostatic)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 15:14
S78	100	S76 and frame with carrier	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 15:21
S79	1	S76 and frame with polyimide	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 15:22
S80	24	S76 and frame with film	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 08:28
S81	10	("3874525" | "3968885" | "4875824" | "5382127" | "5501568" | "5711647" | "5824185" | "5851296" | "6250870" | "6413459").PN. OR ("6652784").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 15:28
S82	10	S73 and carrier same clamp$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 07:47
S83	227	118/721.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 16:39
S84	27	S83 and chuck	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 16:42
S85	5	polyimid with conduct$4 with (film or tape) with (substrate or wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 16:43
S86	35	polyimid with (film or tape) with (substrate or wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 16:47
S87	17714	polyimide adj film	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 16:57
S88	7996	polyimide adj film same (substrate or wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 16:57
S89	108	polyimide adj film same (substrate or wafer) same chuck	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 16:58
S91	44	polyimide adj film with (substrate or wafer) same chuck	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 16:59
S92	11	polyimide adj film with (substrate or wafer) with (conduct$3 or metal)same chuck	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/03 16:59

EAST Search History

S93	442	414/941.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 07:47
S94	55	S93 and (carrier or plate or film) same clamp$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 07:53
S95	6	S93 and film adj frame	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 07:54
S96	2309	414/935-941.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 07:54
S97	13	S96 and film adj frame	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 07:59
S98	279	film adj frame with (substrate or wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 07:59
S99	9	film adj frame with (substrate or wafer) same polyimide	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 08:03
S100	16	chuck with different adj polar$3	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 08:24
S101	59	S96 and (adher$3 or adhesive) with film	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 08:28
S102	1	("4,771,730").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/05/04 14:55
S103	0	("polyimidewith.mu.m").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/05/04 14:55
S104	0	polyimide with ".mu.m"	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 14:56
S105	0	polyimide with ".mu.m"	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 14:56
S106	0	polyimide with ".mu"	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 14:57
S107	0	polyimide with (".mu.m")	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 16:34

EAST Search History

S108	41	chuck with short adj circuit	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 16:43
S109	1	chuck same bipolar with short adj circuit	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/04 16:43